

February 2010

FFB20UP20DN_F085 10A, 200V Ultrafast Dual Rectifiers

Features

- High Reverse Voltage : V_{RRM} = 200V
- Avalanche Energy Rated
- Planar Construction

Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits
- Qualified to AEC Q101
- RoHS Compliant

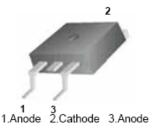
Description

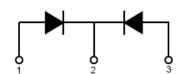
The FFB20UP20DN_F085 is an ultrafast rectifier. It has a low forward voltage drop and is a silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast recovery minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.



Pin Assignments





Anode 2. Cathode 3. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V_{RRM}	Peak Repetitive Reverse Voltage	200	V	
V _{RWM}	Working Peak Reverse Voltage	200	V	
V _R	DC Blocking Voltage		200	V
I _{f(avg)}	Average Rectified Forward Current @ T _C = 155°C		10	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave		100	Α
T _{J,} T _{STG}	Operating Junction and Storage Temperature		-55 to +175	°C

Thermal Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JC}^{1}$	Maximum Thermal Resistance, Junction to Case	3.5	°C/W

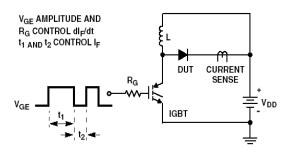
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size Tape Width		Quantity	
F20UP20DN	FFB20UP20DN_F085	TO-263	13"	24mm	800	

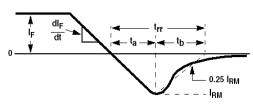
Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max	Units
V _F ²	I _F = 10A I _F = 10A	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 150^{\rm o}{\rm C}$	-	-	1.15 1.0	V V
I_R^2	V _R = 200V V _R = 200V	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 150^{\rm o}{\rm C}$	-	1 1	10 250	μ Α μ Α
t _{rr}	$I_F = 1A$, di/dt = 200A/ μ s, $V_{CC} = 130V$ $I_F = 10A$, di/dt = 200A/ μ s, $V_{CC} = 130V$	$T_C = 25$ °C $T_C = 25$ °C	-	15 27	25 40	ns ns
t _a t _b Q _{rr}	$I_F = 10A$, di/dt = 200A/ μ s, $V_{CC} = 130V$	$T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$	- - -	21 6 50		ns ns nC
W _{AVL}	Avalanche Energy (L = 20mH)		10	-	-	mJ

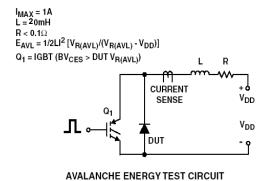
- Notes
 1: Rth_jc value is specified for each die
 2: Pulse: Test Pulse width = 300S, Duty Cycle = 2%

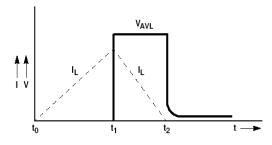






t_{rr} WAVEFORMS AND DEFINITIONS





Typical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

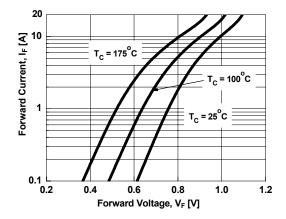


Figure 1. Typical Forward Voltage Drop

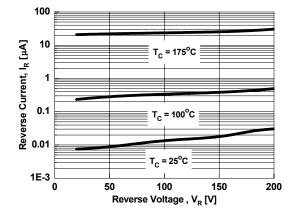


Figure 2. Typical Reverse Current

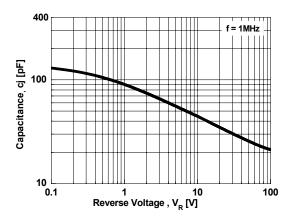


Figure 3. Typical Junction Capacitance

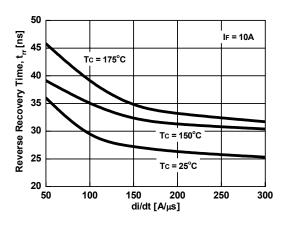


Figure 4. Typical Reverse Recovery Time

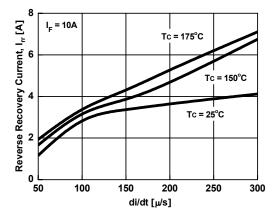


Figure 5. Typical Reverse Recovery Current

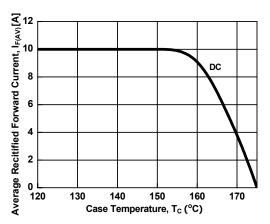


Figure 6. Case Temperature, T_c [°C]

Dimensions in Millimeters

Ultrafast Recovery Power Rectifier

Package Demensions D2-PAK -A-10.67 9.65 _1.68 □1.00 9.65 8.38 9.00 MIN 1.78 MAX (2.12) 1.50 MIN ♦ 0.25 B A 5.08 5.08 -LAND PATTERN RECOMMENDATION -B-4.83 4.06 6.22 MIN-1.65 1.14 6.86 MIN 15.88 14.61 -SEE DETAIL A NOTES: UNLESS OTHERWISE SPECIFIED UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS. REFERENCE JEDEC, TO-263, ISSUE D, VARIATION AB, DATED JULY 2003. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M — 1982. LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE). PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL. CAGE PLANE 0.25 △ 0.10 B 0.25 MAX (5.38)SEATING PLANE DETAIL A, ROTATED 90°

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